

PATENTS ONLY

05-28-2008



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1. Name of party or parties
interest:

Ze Zhang
Lianqi Wei
Shufeng Ye
Yunfa Chen
Peng Liu
Yingkun Zou
Xinming Zou
Jianping Qiu

Address of party or parties

receiving an interest:

Name: INSTITUTE OF PROCESS
ENGINEERING, CHINESE
ACADEMY OF SCIENCES, No. 1,
Beiertiao, Zhongguancun, Haidian
District, Beijing, 100080, China
and
DALIAN RINO ENVIRONMENT
ENGINEERING SCIENCE AND
TECHNOLOGY CO., LTD., No. 11,
Youquan Road, Zhanqian Street,
Jinzhou District, Dalian City, Liaoning
Province, 116100, China

3. Description of the interest conveyed:

☒ Assignment
☐ Merger
☐ Change of Name
☐ Security Agreement

Other:

Execution Date: April 27, 2008

4. Application number(s) or patent number(s).
Additional sheet attached?YES ☐ NO ☒If the document is being filed together with a
new application, the execution date of the
application is:A. Patent Application no.(s): 12/122,366 filed
May 16, 2008

B. Patent no.(s):

5. Name and address of party to whom
correspondence concerning this cover sheet
should be mailed:

Name: Mark C. Zimmerman
Reg. No. 44,006
HANLEY, FLIGHT & ZIMMERMAN, LLC
Street Address: 150 S. Wacker Drive
Suite 2100
City: Chicago
State: Illinois
Zip: 60606

6. Number of applications and/or patents
identified on this cover sheet: 17. Amount of fee enclosed or authorized to be
charged:

\$40.00

8. Any additional required fee may be charged,
or any overpayment credited to our deposit
account: 50-24559. To the best of my knowledge and belief, the information contained on this cover sheet is true
and correct and any copy submitted is a true copy of the original document.

Date: 5/22/2008

Mark C. Zimmerman

Registration No.: 44,006

Total number of pages including cover sheet, attachments, and document: 4

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ASSIGNMENT

Serial No: 12/122,366

Filed: May 16, 2008

Title: INORGANIC COMPOSITE BINDERS WITH HIGH-TEMPERATURE
RESISTANCE AND METHODS FOR PRODUCING THE SAME

For good and valuable consideration, the receipt and sufficiency whereof are hereby acknowledged, the undersigned hereby assigns to INSTITUTE OF PROCESS ENGINEERING, CHINESE ACADEMY OF SCIENCES, No. 1 Beiertiao, Zhongguancun, Haidian District, Beijing, 100080, China, and DALIAN RINO ENVIRONMENT ENGINEERING SCIENCE AND TECHNOLOGY CO., LTD., No. 11 Youquan Road, Zhanqian Street, Jinzhou District, Dalian City, Liaoning Province, 116100, China, (hereinafter "Assignee"), its successors and assigns, the entire right, title and interest in the invention or improvements of the undersigned disclosed in an application for Letters Patent of the United States, and in said application and any and all other applications, which the undersigned may file, either solely or jointly with others, on said invention or improvements, and in any and all Letters Patent of the United States, which may be obtained on any of said applications, and in any reissue or extension thereof.

The undersigned hereby authorizes and requests the Commissioner of Patents and Trademarks to issue said Letters Patent to said assignee.

The undersigned hereby authorizes and requests the attorneys of record in said application to insert in this assignment the execution date and/or filing date and serial number of said application when officially known.

The undersigned warrants himself to be the owner of the interest herein assigned and to have the right to make this assignment and further warrants that there are no outstanding prior assignments, licenses, or other rights in the interest herein assigned.

For said consideration the undersigned hereby agrees, upon the request and at the expense of said assignee, its successors and assigns, to execute any and all divisional, continuation, continuation-in-part and substitute applications for said invention or improvements, and any necessary oath or affidavit relating thereto, and any application for the reissue or extension of any Letters Patent that may be granted upon said application, that said assignee, its successors or assigns, may deem necessary or expedient, and for said consideration the undersigned further agrees upon the request of said assignee, its successors or assigns, in the event of any application or Letters Patent assigned herein becoming involved in Interference, to cooperate to the best of the ability of the undersigned with said assignee, its successors or assigns, in the matters of preparing and executing the preliminary statement and giving and producing evidence in support thereof, the undersigned hereby agreeing to perform,

upon request, any and all affirmative acts to obtain said Letters Patent, and vest all rights therein hereby conveyed in said assignee, its successors and assigns, whereby said Letters Patent will be held and enjoyed by said assignee, its successors and assigns, to the full end of the term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by the undersigned if this assignment and sale had not been made.

Date: April 27, 2008 Signature Ze Zhang
Name Ze Zhang

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Date: April 27, 2008 Signature Lianqi Wei
Name Lianqi Wei

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Date: April 27, 2008 Signature Shufeng Ye
Name Shufeng Ye

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Date: April 27, 2008 Signature Yunfa Chen
Name Yunfa Chen

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Date: April 27, 2008 Signature Peng Liu
Name Peng Liu

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Date: April 27, 2008 Signature Yingkun Zou
Name Yingkun Zou

* * * * *

Date: April 27, 2008 Signature Xinming Zou
Name Xinming Zou